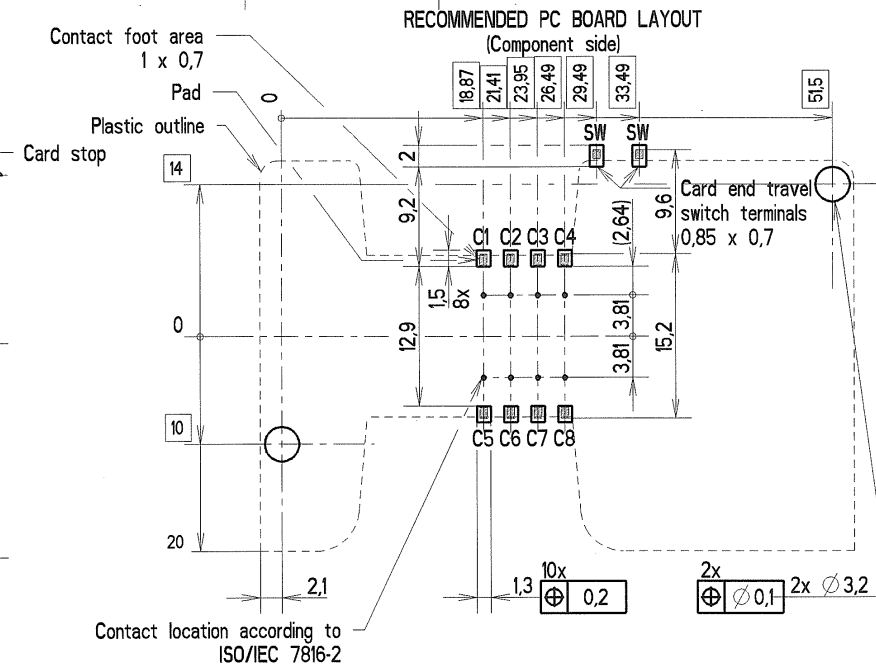
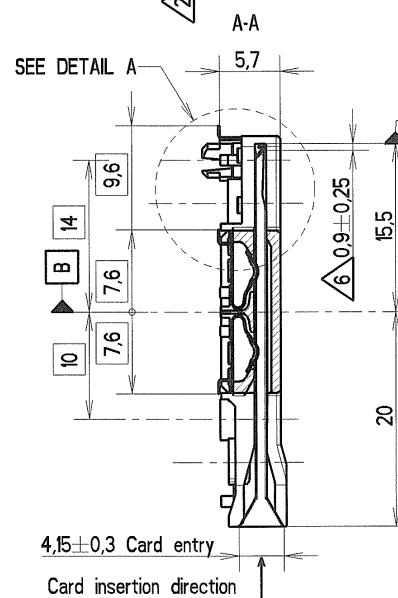
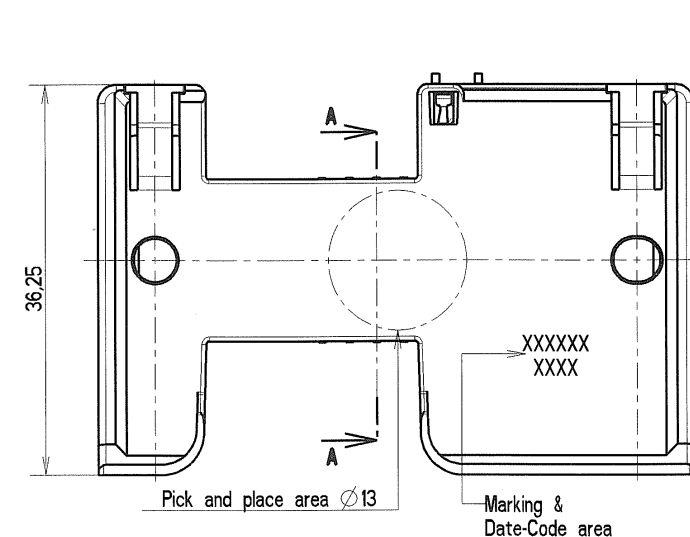
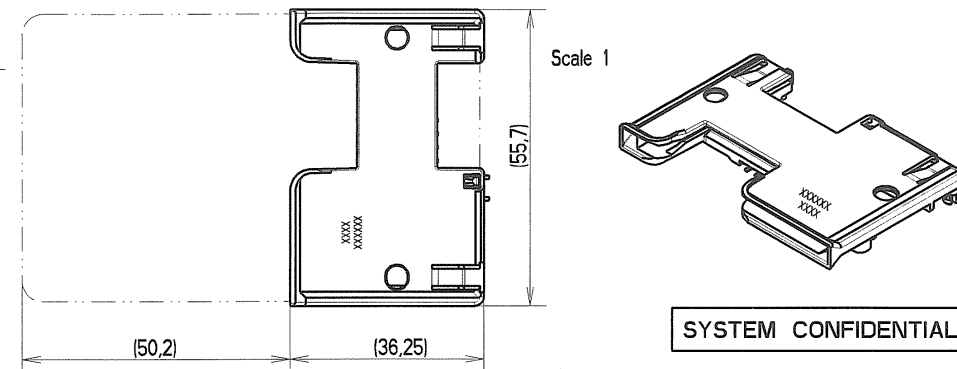
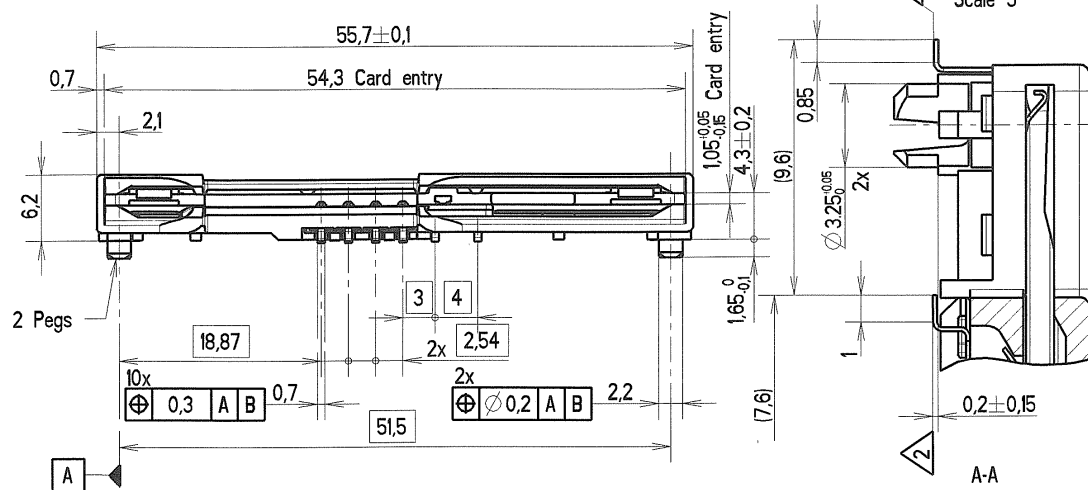


REV.	N° DCR	NATURE DE LA MODIFICATION	DATE	VISA
D	ECR-1406	References table added ; designation and marking updated	11/09/2007	V.P
E	ECR-2182	Designation updated	07/05/2008	CD



Packaging	Packaging drawing	Marking	Designation	Part Number
Tray	030278Y0043	2013T	CCM01-2013LFT T30/	Y1112-2013A LFT
Reel	030278Y0059		CCM01-2013LFT R201	Y1112-2013B LFT

Notes : - 1 - Termination to PCB : SMT reflow soldering

Temperature/time profile according to :
C&K PS-LF-001 specification.

Since there are no boardlocks , the connector must be held in place on the PCB across the top face of the cover.

- 2 - Level of each contact tail compared to the nearest plastic stand-off.

Coplanarity of metal soldering surfaces : 0,15 mm

- 3 - Recommendation for solder paste thickness > 0,2 mm.

- 4 - 2,5 microns min tin plating on contact terminal areas.
0,1 microns min gold plating on switch terminal areas.

- 5 - Contact forces :

- max 0,5 N per contact with max. card thickness.

- min 0,2 N per contact with min. card thickness.

- 6 - Card end travel switch NO activates when the sliding card is 0,9 mm from the card stop.

- 7 - In case of customer accessories integration requesting an interface with CCM, please ask C&K for a 3D model.

MATIERE	TRAITEMENT	PROTECTION
SAUF INDIQUE : -COTES DONNEES AVANT PROTECTION -BAVURES ET ARETES VIVES SUPPRIMEES	TOL. LINEAIRE ± 0,1 TOL. ANGULAIRE ± 2° ETAT DE SURFACE Ra	DIMENSIONS CRITIQUES DIMENSIONS SPC LANGAGE E
DESSINE P.DAUBIGNEY VERIFIE G.PINON APPROUVE L.KUBAT	DATE 19-05-05 DATE 07/05/2008 DATE 07/05/2008	ANALYSE Y TAB. FAM. Y PRO/E Y
DESIGNATION CCM01-2013 LFT Specific version 2 pgs 3,25 mm		
C&K Components		
BP 359 - 39105 Dole - FRANCE -	PROJECTION 1ER DEDRE ECHELLE 2	NUMERO CU REV E